

MCP/Timepix soft X-ray event counting detectors: current and near future capabilities

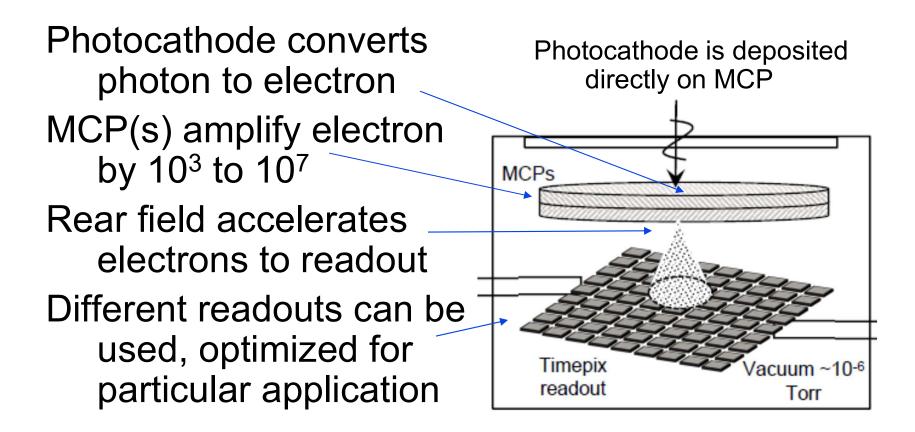
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MCP detector configuration for soft X-ray applications



No ideal detector fitting all applications. Compromises are always to be found.



Advantages/disadvantages of MCP detectors in photon counting applications

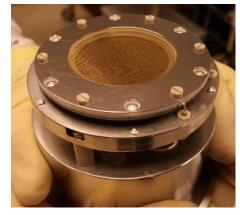
- No readout noise
- Time and position for every detected particle (~6 µm with event centroiding, ~20 ps event spread time in MCP)
- Event counting
- TOF applications
- High counting rates possible with latest readouts
- High detection efficiency (neutrons, soft X-rays)
- No intrinsic energy resolution
- Small area (~ 3 cm, may be up to 10 cm)
- Require vacuum
- Require high voltage
- Image distortions





Detector hardware implementations

Synchrotron beamline detectors: ARPES – angular resolved photoelectron emission spectroscopy



RIXS and XPCS @ ALS



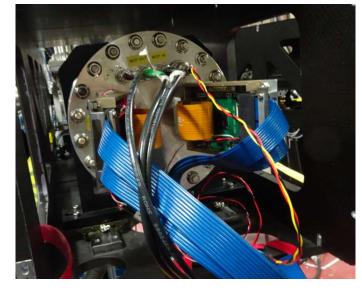
ALS MCP/Timepix detector, used at LCLS once

COS detector Installed on Hubble telescope





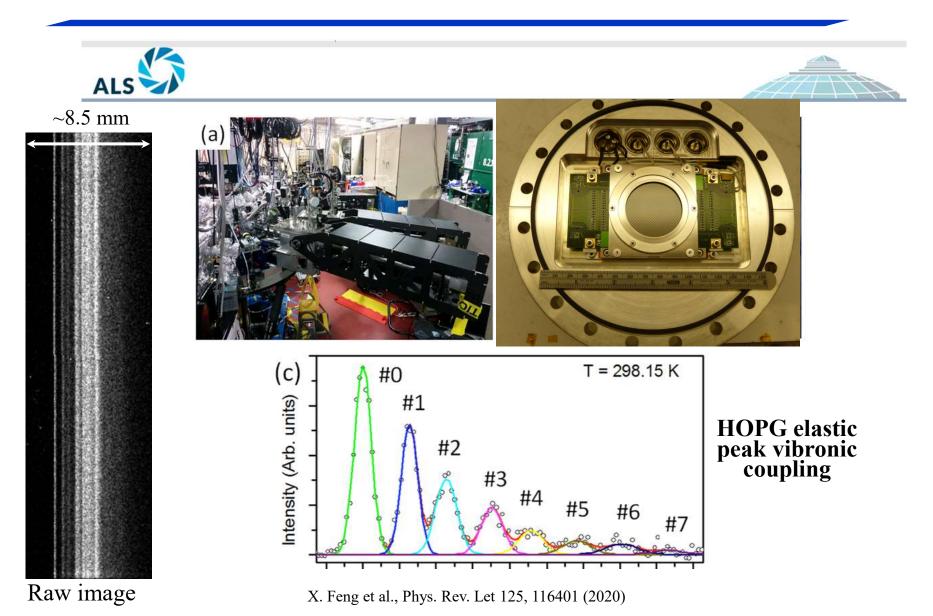
NASA Shuttle STS-125 Mission



Scientific Reports (2020) 10:22226 Phys. Rev. Let 125, 116401 (2020) Phys. Rev. Let 126, 117201 (2021)

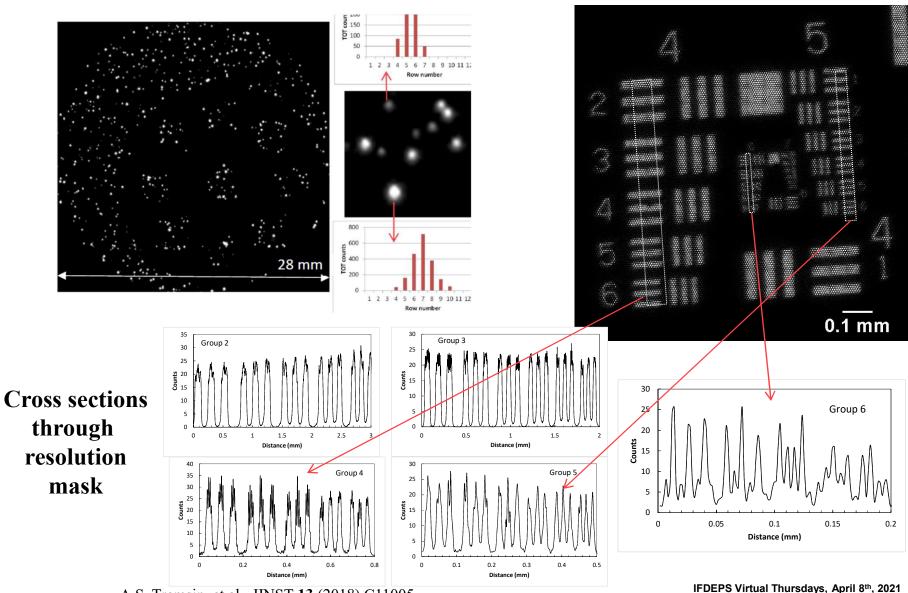


Initial tests of MCP/TPX systems at ALS and LCLS





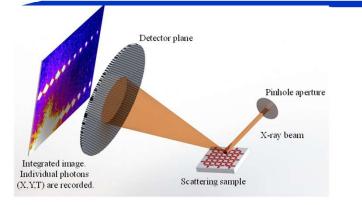
Centroided images: ~6.5 µm resolution

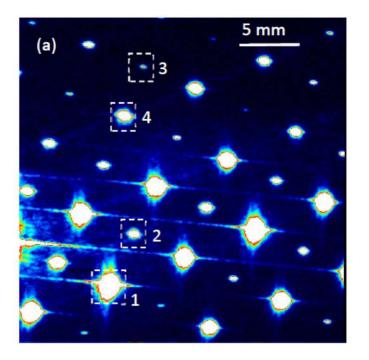


A.S. Tremsin, et al., JINST **13** (2018) C11005



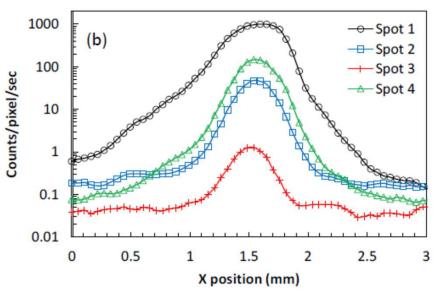
Development of 2x2 MCP/TPX3 detector ALS





Beamline experiments on the MCP optimization

- MCP/Timepix detectors enable operation at a very large dynamic range (photon counting within very bright and very dim spots at the same time).
- The count rate within different spots in that image





MCP/Timepix soft X-ray detectors roadmap

Gen. 2 (used now)

- **Spatial resolution** 55 µm with 10 ns timing resolution
- Either high spatial resolution (~6 μm), or high timing resolution
- Count rate in high spatial resolution (~6 μm), is limited to ~3 MHz
- **Count rate** with 10 ns and 55 μm is ~ **30 MHz**
- 320 µs readout time (dead time) per frame
- **Power dissipation** ~1W/chip

Gen. 3 (developed UCB/ALS)

- Timing resolution improved to ~2 ns
- Both high spatial (~6 µm) and timing resolution (~2 ns) are possible
- No dead time for readout: event driven readout
- 80 Mhits/s rate per chip
- More heat generated in vacuum (power dissipation ~2 W/chip); power options can be optimized
- Longer cable out of vacuum (LVDS signal output)

Gen. 4

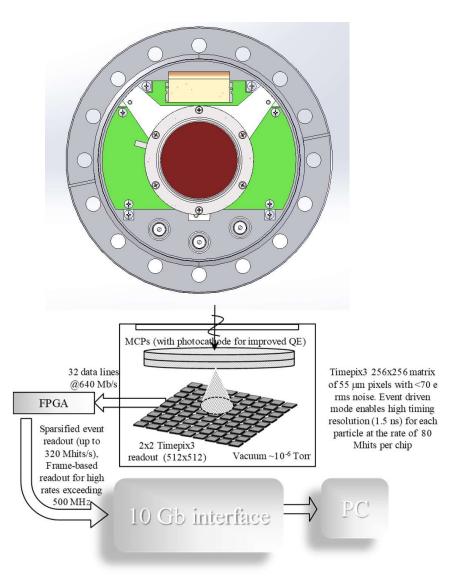
- Timing resolution to be improved to <200 ps
- Larger area per chip (512x488 pixels, 55 µm each)
- 4-side buttable (TSVs)
- Very high data output rates (up to 160 Gb/s)



Development of 2x2 MCP/TPX3 detector



- **2nd phase of the program**: Design of quad 2x2 MCP/TPX3 detector is underway.
- Mechanical design of vacuum hardware. The currently planned mounting on a 6 inch flange is finalized (ASIC in-vacuum board and high speed vacuum feedthrough/connector)
- Design, implementation and optimization of data acquisition firmware for 4 chip readout electronics: use existing 1 chip version.







Thank you for your attention!

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